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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	750
Number of Logic Elements/Cells	6000
Total RAM Bits	56320
Number of I/O	90
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-6se-7t144c

Architecture Overview

Each LatticeECP2/M device contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM™ Embedded Block RAM (EBR) and rows of sys-DSP™ Digital Signal Processing blocks, as shown in Figure 2-1. In addition, the LatticeECP2M family contains SERDES Quads in one or more of the corners. Figure 2-2 shows the block diagram of ECP2M20 with one quad.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional Unit without RAM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM and ROM functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row.

The LatticeECP2/M devices contain one or more rows of sysMEM EBR blocks. sysMEM EBRs are large dedicated 18K fast memory blocks. Each sysMEM block can be configured in a variety of depths and widths of RAM or ROM. In addition, LatticeECP2/M devices contain up to two rows of DSP Blocks. Each DSP block has multipliers and adder/accumulators, which are the building blocks for complex signal processing capabilities.

The LatticeECP2M devices feature up to 16 embedded 3.125Gbps SERDES (Serializer / Deserializer) channels. Each SERDES channel contains independent 8b/10b encoding / decoding, polarity adjust and elastic buffer logic. Each group of four SERDES channels along with its Physical Coding Sub-layer (PCS) block, creates a quad. The functionality of the SERDES/PCS Quads can be controlled by memory cells set during device configuration or by registers that are addressable during device operation. The registers in every quad can be programmed by a soft IP interface, referred to as the SERDES Client Interface (SCI). These quads (up to four) are located at the corners of the devices.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O buffers. The sysI/O buffers of the LatticeECP2/M devices are arranged in eight banks, allowing the implementation of a wide variety of I/O standards. In addition, a separate I/O bank is provided for the programming interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. The PIC logic also includes pre-engineered support to aid in the implementation of high speed source synchronous standards such as SPI4.2, along with memory interfaces including DDR2.

The LatticeECP2/M registers in PFU and sysI/O can be configured to be SET or RESET. After power up and the device is configured, it enters into user mode with these registers SET/RESET according to the configuration setting, allowing the device entering to a known state for predictable system function.

Other blocks provided include PLLs, DLLs and configuration functions. The LatticeECP2/M architecture provides two General PLLs (GPLL) and up to six Standard PLLs (SPLL) per device. In addition, each LatticeECP2/M family member provides two DLLs per device. The GPLLs and DLLs blocks are located in pairs at the end of the bottom-most EBR row; the DLL block is located towards the edge of the device. The SPLL blocks are located at the end of the other EBR/DSP rows.

The configuration block that supports features such as configuration bit-stream decryption, transparent updates and dual boot support is located toward the center of this EBR row. The Ball Grid Array (BGA) package devices in the LatticeECP2/M family supports a sysCONFIG™ port located in the corner between banks four and five, which allows for serial or parallel device configuration.

In addition, every device in the family has a JTAG port. This family also provides an on-chip oscillator. The LatticeECP2/M devices use 1.2V as their core voltage.

ROM Mode

ROM mode uses the LUT logic; hence, Slices 0 through 3 can be used in ROM mode. Preloading is accomplished through the programming interface during PFU configuration.

Routing

There are many resources provided in the LatticeECP2/M devices to route signals individually or as buses with related control signals. The routing resources consist of switching circuitry, buffers and metal interconnect (routing) segments.

The inter-PFU connections are made with x1 (spans two PFU), x2 (spans three PFU) and x6 (spans seven PFU). The x1 and x2 connections provide fast and efficient connections in horizontal and vertical directions. The x2 and x6 resources are buffered, allowing the routing of both short and long connections between PFUs.

The LatticeECP2/M family has an enhanced routing architecture that produces a compact design. The Diamond design software takes the output of the synthesis tool and places and routes the design. Generally, the place and route tool is completely automatic, although an interactive routing editor is available to optimize the design.

sysCLOCK Phase Locked Loops (GPLL/SPLL)

The sysCLOCK PLLs provide the ability to synthesize clock frequencies. All the devices in the LatticeECP2/M family support two General Purpose PLLs (GPLLs) which are full-featured PLLs. In addition, some of the larger devices have two to six Standard PLLs (SPLLs) that have a subset of GPLL functionality.

General Purpose PLL (GPLL)

The architecture of the GPLL is shown in Figure 2-5. A description of the GPLL functionality follows.

CLKI is the reference frequency (generated either from the pin or from routing) for the PLL. CLKI feeds into the Input Clock Divider block. The CLKFB is the feedback signal (generated from CLKOP or from a user clock PIN/logic). This signal feeds into the Feedback Divider. The Feedback Divider is used to multiply the reference frequency.

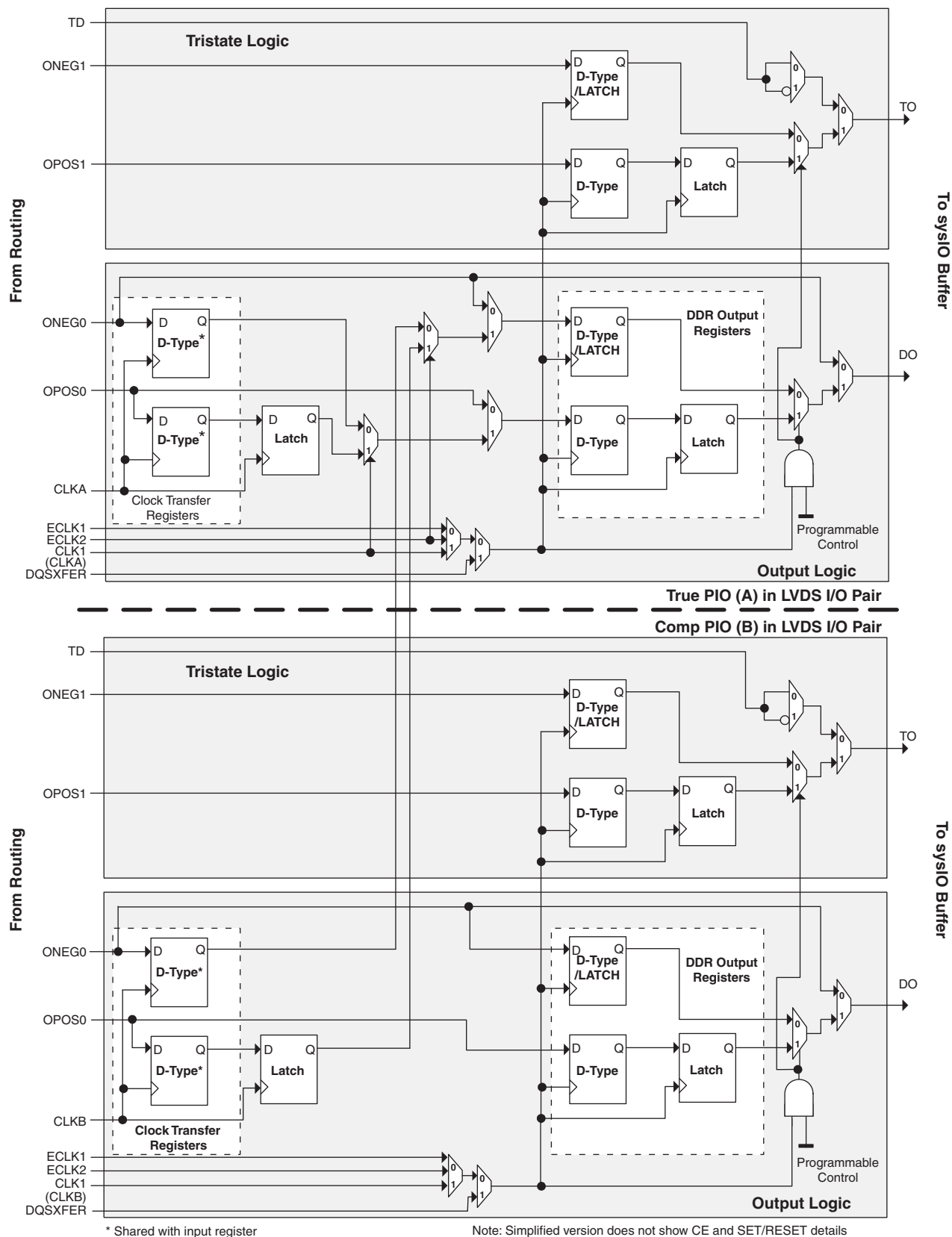
The Delay Adjust Block adjusts either the delays of the reference or feedback signals. The Delay Adjust Block can either be programmed during configuration or can be adjusted dynamically. The setup, hold or clock-to-out times of the device can be improved by programming a delay in the feedback or input path of the PLL, which will advance or delay the output clock with reference to the input clock.

Following the Delay Adjust Block, both the input path and feedback signals enter the Voltage Controlled Oscillator (VCO) block. In this block the difference between the input path and feedback signals is used to control the frequency and phase of the oscillator. A LOCK signal is generated by the VCO to indicate that the VCO has locked onto the input clock signal. In dynamic mode, the PLL may lose lock after a dynamic delay adjustment and not relock until the t_{LOCK} parameter has been satisfied. LatticeECP2/M devices have two dedicated pins on the left and right edges of the device for connecting optional external capacitors to the VCO. This allows the PLLs to operate at a lower frequency. This is a shared resource that can only be used by one PLL (GPLL or SPLL) per side.

The output of the VCO then enters the post-scalar divider. The post-scalar divider allows the VCO to operate at higher frequencies than the clock output (CLKOP), thereby increasing the frequency range. A secondary divider takes the CLKOP signal and uses it to derive lower frequency outputs (CLKOK). The Phase/Duty Select block adjusts the phase and duty cycle of the CLKOP signal and generates the CLKOS signal. The phase/duty cycle setting can be pre-programmed or dynamically adjusted.

The primary output from the post scalar divider CLKOP along with the outputs from the secondary divider (CLKOK) and Phase/Duty select (CLKOS) are fed to the clock distribution network.

Figure 2-31. Output and Tristate Block for Left, Right and Bottom Edges



LatticeECP2M Supply Current (Standby)^{1, 2, 3, 4}
Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ⁵	Units
I_{CC}	Core Power Supply Current	ECP2M20	25	mA
		ECP2M35	50	mA
		ECP2M50	85	mA
		ECP2M70	100	mA
		ECP2M100	100	mA
I_{CCAUX}	Auxiliary Power Supply Current	ECP2M20	24	mA
		ECP2M35	24	mA
		ECP2M50	24	mA
		ECP2M70	24	mA
		ECP2M100	24	mA
I_{CCGPLL}	GPLL Power Supply Current (per GPLL)	All Devices	0.5	mA
I_{CCSPLL}	GPLL Power Supply Current (per SPLL)	All Devices	0.5	mA
I_{CCIO}	Bank Power Supply Current (Per Bank)	ECP2M20	2	mA
		ECP2M35	2	mA
		ECP2M50	2	mA
		ECP2M70	2	mA
		ECP2M100	2	mA
I_{CCJ}	V_{CCJ} Power Supply Current	All Devices	3	mA

1. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.

2. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.

3. Frequency 0MHz.

4. Pattern represents a "blank" configuration data file.

5. $T_J = 25^{\circ}\text{C}$, power supplies at normal voltage.

SERDES External Reference Clock (LatticeECP2M Family Only)

The external reference clock selection and its interface are a critical part of system applications for this product. Table 3-14 specifies reference clock requirements, over the full range of operating conditions.

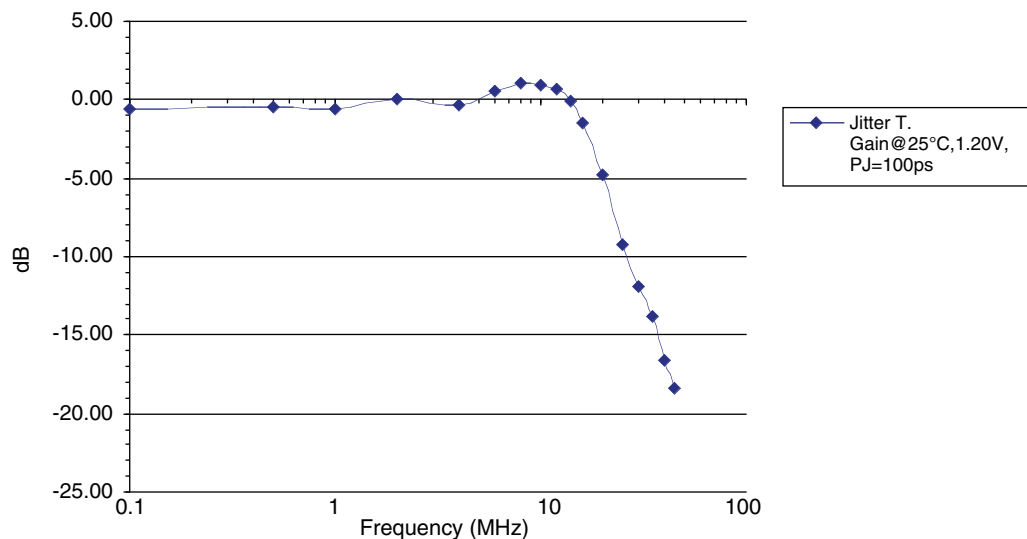
Table 3-14. External Reference Clock Specification (refclkp/refclkn)

Symbol	Description	Min.	Typ.	Max.	Units
F _{REF}	Frequency range	25	—	320	MHz
F _{REF-PPM}	Frequency tolerance	-300	—	300	ppm
V _{REF-IN-SE}	Input swing, single-ended clock ¹	100	—	1200	mV, p-p
V _{REF-IN}	Input levels	0	—	V _{CCP} + 0.8	V
V _{REF-CM-DC}	Input common mode range (DC coupled)	0.5	—	1.2	V
V _{REF-CM-AC}	Input common mode range (AC coupled) ²	0	—	1.5	V
D _{REF}	Duty cycle ³	40	—	60	%
T _{REF-R}	Rise time (20% to 80%)		500	1000	ps
T _{REF-F}	Fall time (80% to 20%)		500	1000	ps
Z _{REF-IN-TERM}	Input termination		50/2K		Ohms
C _{REF-IN-CAP}	Input capacitance ⁴	—	—	1.5	pF

1. The signal swing for a single-ended input clock must be as large as the p-p differential swing of a differential input clock to get the same gain at the input receiver. Lower swings for the clock may be possible, but will tend to increase jitter.
2. When AC coupled, the input common mode range is determined by:

$$(\text{Min input level}) + (\text{Peak-to-peak input swing})/2 \leq (\text{Input common mode voltage}) \leq (\text{Max input level}) - (\text{Peak-to-peak input swing})/2$$
3. Measured at 50% amplitude.
4. Input capacitance of 1.5pF is total capacitance, including both device and package.

Figure 3-13. Jitter Transfer



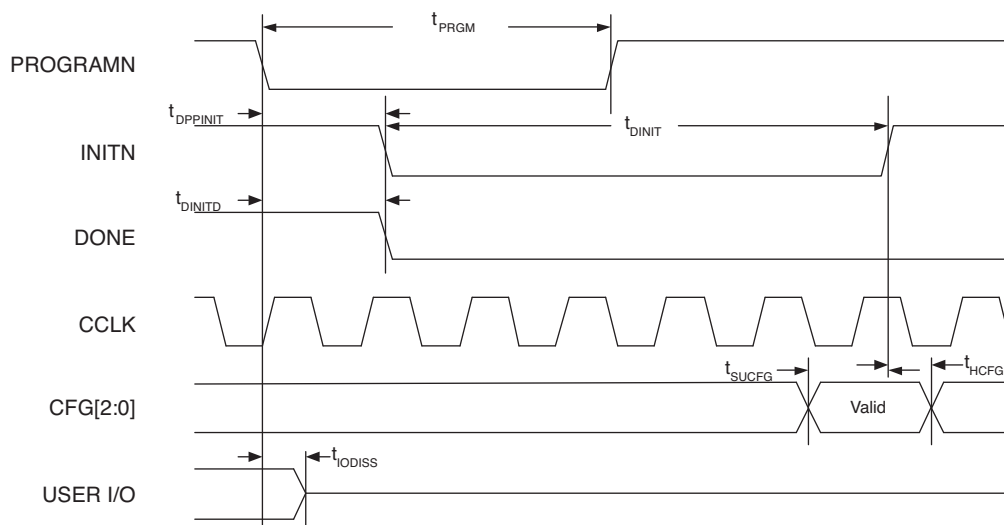
Note: This graph is for a nominal device.

SERDES Power-Down/Power-Up Specification

Table 3-15. Power-Down and Power-Up Specification

Symbol	Description	Max.	Units
t _{PWRDN}	Power-down time after all power down register bits set to '0'	10	μs
t _{PWRUP}	Power-up time after all power down register bits set to '1'	100	μs

Figure 3-18. Configuration from PROGRAMN Timing



1. The CFG pins are normally static (hard wired)

Figure 3-19. Wake-Up Timing

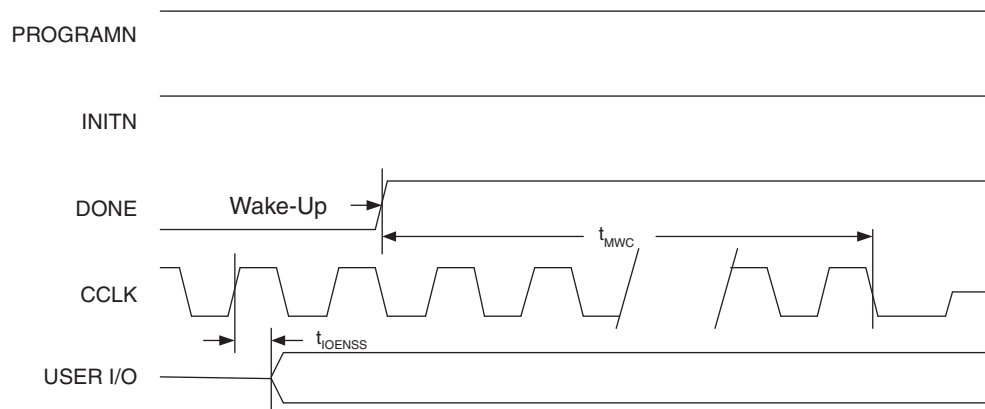
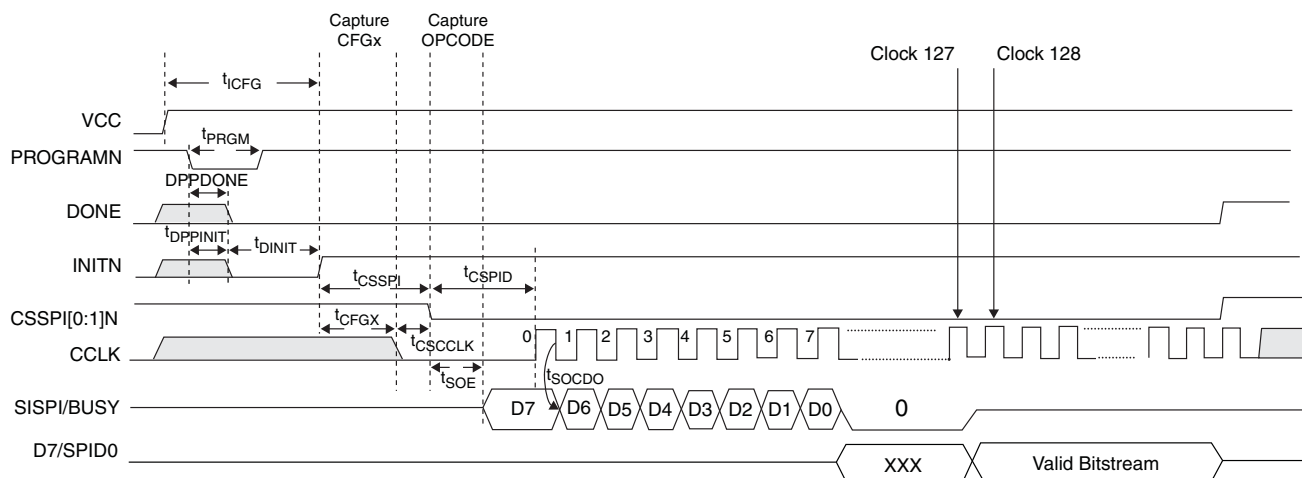


Figure 3-20. SPI/SPI_m Configuration Waveforms



LatticeECP2 Pin Information Summary, LFE2-20 and LFE2-35

Pin Type		LFE2-20				LFE2-35	
		208 PQFP	256 fpBGA	484 fpBGA	672 fpBGA	484 fpBGA	672 fpBGA
Single Ended User I/O		131	193	331	402	331	450
Differential Pair User I/O		62	96	165	200	165	224
Configuration	TAP Pins	5	5	5	5	5	5
	Muxed Pins	14	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7	7
Non Configuration	Muxed Pins	42	54	60	64	60	68
	Dedicated Pins	3	3	3	3	3	3
VCC		14	7	18	24	16	22
VCCAUX		8	4	16	16	16	16
VCCPLL		0	0	0	0	2	2
VCCIO	Bank0	2	2	4	5	4	5
	Bank1	2	2	4	5	4	5
	Bank2	2	2	4	5	4	5
	Bank3	2	2	4	5	4	5
	Bank4	2	2	4	5	4	5
	Bank5	2	2	4	5	4	5
	Bank6	2	2	4	5	4	5
	Bank7	2	2	4	5	4	5
	Bank8	2	1	2	2	2	2
GND, GND0 to GND7		22	20	60	72	60	72
NC		0	1	8	101	8	102
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	18/9	18/9	50/25	67/33	50/25	67/33
	Bank1	18/9	34/17	46/23	52/26	46/23	52/26
	Bank2	11/5	20/10	34/17	36/18	34/17	48/24
	Bank3	11/5	12/6	22/11	32/16	22/11	42/21
	Bank4	19/9	32/16	46/23	50/25	46/23	54/27
	Bank5	18/9	17/8	46/23	68/34	46/23	68/34
	Bank6	18/8	26/13	40/20	48/24	40/20	58/29
	Bank7	12/6	20/10	33/16	35/17	33/16	47/23
	Bank8	6/2	14/7	14/7	14/7	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0	0
	Bank2 (Right Edge)	4	5	9	9	9	12
	Bank3 (Right Edge)	3	3	5	8	5	9
	Bank4 (Bottom Edge)	0	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0	0
	Bank6 (Left Edge)	6	7	10	12	10	13
	Bank7 (Left Edge)	5	5	8	8	8	11
	Bank8 (Right Edge)	0	0	0	0	0	0

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
A6	PT21A	0		T	PT30A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
C7	PT17B	0		C	PT26B	0		C	
D10	PT18B	0		C	PT27B	0		C	
C6	PT17A	0		T	PT26A	0		T	
E10	PT18A	0		T	PT27A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
F10	PT15B	0		C	PT24B	0		C	
B6	PT16B	0		C	PT25B	0		C	
D9	PT15A	0		T	PT24A	0		T	
B5	PT16A	0		T	PT25A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
A5	PT13B	0		C	PT22B	0		C	
F9	PT14B	0		C	PT23B	0		C	
A4	PT13A	0		T	PT22A	0		T	
E9	PT14A	0		T	PT23A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
G8	PT11B	0		C	PT20B	0		C	
A3	PT12B	0		C	PT21B	0		C	
E8	PT11A	0		T	PT20A	0		T	
A2	PT12A	0		T	PT21A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
-	-	-			VCCIO0	0			
C3	PT10B	0		C	PT10B	0		C	
B3	PT10A	0		T	PT10A	0		T	
-	-	-			GNDIO0	-			
E7	PT8B	0		C	PT8B	0		C	
F8	PT9B	0		C	PT9B	0		C	
F7	PT8A	0		T	PT8A	0		T	
D7	PT9A	0		T	PT9A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
D4	PT6B	0		C	PT6B	0		C	
D5	PT7B	0		C	PT7B	0		C	
C4	PT6A	0		T	PT6A	0		T	
D6	PT7A	0		T	PT7A	0		T	
GNDIO	GNDIO0	-			GNDIO	-			
J7	PT4B	0		C	PT4B	0		C	
B2	PT5B	0		C	PT5B	0		C	
H7	PT4A	0		T	PT4A	0		T	
B1	PT5A	0		T	PT5A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
D1	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C	
D3	PT3B	0		C	PT3B	0		C	
C1	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T	

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AE17	PB51B	4	BDQ51	C	PB51B	4	BDQ51	C	
AB19	PB52A	4	BDQ51	T	PB52A	4	BDQ51	T	
AE19	PB52B	4	BDQ51	C	PB52B	4	BDQ51	C	
AF17	PB53A	4	BDQ51	T	PB53A	4	BDQ51	T	
AE18	PB53B	4	BDQ51	C	PB53B	4	BDQ51	C	
VCCIO	VCCIO4	4			VCCIO4	4			
W16	PB54A	4	BDQ51	T	PB54A	4	BDQ51	T	
AA17	PB54B	4	BDQ51	C	PB54B	4	BDQ51	C	
AF18	PB55A	4	BDQ51	T	PB55A	4	BDQ51	T	
AF19	PB55B	4	BDQ51	C	PB55B	4	BDQ51	C	
GND	GNDIO4	-			GNDIO4	-			
AA19	NC	-			PB56A	4	BDQ60	T	
W17	NC	-			PB56B	4	BDQ60	C	
Y19	NC	-			PB57A	4	BDQ60	T	
Y17	NC	-			PB57B	4	BDQ60	C	
AF20	NC	-			NC	-			
VCCIO	VCCIO4	4			VCCIO4	4			
AE20	NC	-			NC	-			
AA20	NC	-			NC	-			
W18	NC	-			NC	-			
AD20	NC	-			NC	-			
GND	GNDIO4	-			GNDIO4	-			
AE21	NC	-			NC	-			
AF21	NC	-			NC	-			
AF22	NC	-			NC	-			
VCCIO	VCCIO4	4			VCCIO4	4			
GND	GNDIO4	-			GNDIO4	-			
AE22	PB56A	4	BDQ60	T	PB65A	4	BDQ69	T	
AD22	PB56B	4	BDQ60	C	PB65B	4	BDQ69	C	
AF23	PB57A	4	BDQ60	T	PB66A	4	BDQ69	T	
AE23	PB57B	4	BDQ60	C	PB66B	4	BDQ69	C	
AD23	PB58A	4	BDQ60	T	PB67A	4	BDQ69	T	
AC23	PB58B	4	BDQ60	C	PB67B	4	BDQ69	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AB20	PB59A	4	BDQ60	T	PB68A	4	BDQ69	T	
AC20	PB59B	4	BDQ60	C	PB68B	4	BDQ69	C	
GND	GNDIO4	-			GNDIO4	-			
AB21	PB60A	4	BDQS60	T	PB69A	4	BDQS69	T	
AC22	PB60B	4	BDQ60	C	PB69B	4	BDQ69	C	
W19	PB61A	4	BDQ60	T	PB70A	4	BDQ69	T	
AA21	PB61B	4	BDQ60	C	PB70B	4	BDQ69	C	
AF24	PB62A	4	BDQ60	T	PB71A	4	BDQ69	T	
AE24	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C	
VCCIO	VCCIO4	4			VCCIO4	4			
Y20	PB63A	4	BDQ60	T	PB72A	4	BDQ69	T	
AB22	PB63B	4	BDQ60	C	PB72B	4	BDQ69	C	

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A2	GND	-			GND	-		
A25	GND	-			GND	-		
AA18	GND	-			GND	-		
AA24	GND	-			GND	-		
AA3	GND	-			GND	-		
AA9	GND	-			GND	-		
AD11	GND	-			GND	-		
AD16	GND	-			GND	-		
AD21	GND	-			GND	-		
AD6	GND	-			GND	-		
AE1	GND	-			GND	-		
AE26	GND	-			GND	-		
AF2	GND	-			GND	-		
AF25	GND	-			GND	-		
B1	GND	-			GND	-		
B26	GND	-			GND	-		
C11	GND	-			GND	-		
C16	GND	-			GND	-		
C21	GND	-			GND	-		
C6	GND	-			GND	-		
F18	GND	-			GND	-		
F24	GND	-			GND	-		
F3	GND	-			GND	-		
F9	GND	-			GND	-		
J13	GND	-			GND	-		
J14	GND	-			GND	-		
J21	GND	-			GND	-		
J6	GND	-			GND	-		
K10	GND	-			GND	-		
K11	GND	-			GND	-		
K13	GND	-			GND	-		
K14	GND	-			GND	-		
K16	GND	-			GND	-		
K17	GND	-			GND	-		
L10	GND	-			GND	-		
L11	GND	-			GND	-		
L16	GND	-			GND	-		
L17	GND	-			GND	-		
L24	GND	-			GND	-		
L3	GND	-			GND	-		
M13	GND	-			GND	-		
M14	GND	-			GND	-		
N10	GND	-			GND	-		
N12	GND	-			GND	-		
N13	GND	-			GND	-		
N14	GND	-			GND	-		

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
W5	PL71B	6	LDQ75	C (LVDS)*	PL84B	6	LDQ88	C (LVDS)*	
AC1	PL72A	6	LDQ75	T	PL85A	6	LDQ88	T	
AD1	PL72B	6	LDQ75	C	PL85B	6	LDQ88	C	
VCCIO	VCCIO6	6			VCCIO6	6			
Y6	PL73A	6	LDQ75	T (LVDS)*	PL86A	6	LDQ88	T (LVDS)*	
Y5	PL73B	6	LDQ75	C (LVDS)*	PL86B	6	LDQ88	C (LVDS)*	
AE2	PL74A	6	LDQ75	T	PL87A	6	LDQ88	T	
AD2	PL74B	6	LDQ75	C	PL87B	6	LDQ88	C	
GND	GNDIO6	-			GNDIO6	-			
AB3	PL75A	6	LDQS75	T (LVDS)*	PL88A	6	LDQS88	T (LVDS)*	
AB2	PL75B	6	LDQ75	C (LVDS)*	PL88B	6	LDQ88	C (LVDS)*	
W7	PL76A	6	LDQ75	T	PL89A	6	LDQ88	T	
VCCIO	VCCIO6	6			VCCIO6	6			
W8	PL76B	6	LDQ75	C	PL89B	6	LDQ88	C	
Y7	PL77A	6	LDQ75	T (LVDS)*	PL90A	6	LDQ88	T (LVDS)*	
Y8	PL77B	6	LDQ75	C (LVDS)*	PL90B	6	LDQ88	C (LVDS)*	
AC2	PL78A	6	LDQ75	T	PL91A	6	LDQ88	T	
GND	GNDIO6	-			GNDIO6	-			
AD3	PL78B	6	LDQ75	C	PL91B	6	LDQ88	C	
AC3	TCK	-			TCK	-			
AA8	TDI	-			TDI	-			
AB4	TMS	-			TMS	-			
AA5	TDO	-			TDO	-			
AB5	VCCJ	-			VCCJ	-			
AE3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T	
AF3	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C	
AC4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T	
AD4	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C	
AE4	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T	
AF4	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			
V9	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T	
W9	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C	
GND	GNDIO5	-			GNDIO5	-			
AA6	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T	
AB6	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C	
AC5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T	
AD5	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C	
AA7	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T	
AB7	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			
AE5	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T	
AF5	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C	
AC7	PB10A	5	BDQ6	T	PB10A	5	BDQ6	T	
AD7	PB10B	5	BDQ6	C	PB10B	5	BDQ6	C	
VCCIO	VCCIO5	5			VCCIO5	5			

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
G24	PR14B	2	RDQ16	C (LVDS)*	PR27B	2	RDQ29	C (LVDS)*	
G23	PR14A	2	RDQ16	T (LVDS)*	PR27A	2	RDQ29	T (LVDS)*	
VCCIO	VCCIO2	2			VCCIO2	2			
K19	PR13B	2	RDQ16	C	PR26B	2	RDQ29	C	
J19	PR13A	2	RDQ16	T	PR26A	2	RDQ29	T	
D26	PR12B	2	RDQ16	C (LVDS)*	PR25B	2	RDQ29	C (LVDS)*	
C26	PR12A	2	RDQ16	T (LVDS)*	PR25A	2	RDQ29	T (LVDS)*	
F22	PR11B	2	RDQ8	C	PR24B	2	RDQ21	C	
E24	PR11A	2	RDQ8	T	PR24A	2	RDQ21	T	
GND	GNDIO2	-			GNDIO2	-			
D25	PR10B	2	RDQ8	C (LVDS)*	PR23B	2	RDQ21	C (LVDS)*	
C25	PR10A	2	RDQ8	T (LVDS)*	PR23A	2	RDQ21	T (LVDS)*	
D24	PR9B	2	RDQ8	C	PR22B	2	RDQ21	C	
B25	PR9A	2	RDQ8	T	PR22A	2	RDQ21	T	
VCCIO	VCCIO2	2			VCCIO2	2			
H21	PR8B	2	RDQ8	C (LVDS)*	PR21B	2	RDQ21	C (LVDS)*	
G22	PR8A	2	RDQS8	T (LVDS)*	PR21A	2	RDQS21	T (LVDS)*	
B24	PR7B	2	RDQ8	C	PR20B	2	RDQ21	C	
GND	GNDIO2	-			GNDIO2	-			
C24	PR7A	2	RDQ8	T	PR20A	2	RDQ21	T	
D23	PR6B	2	RDQ8	C (LVDS)*	PR19B	2	RDQ21	C (LVDS)*	
C23	PR6A	2	RDQ8	T (LVDS)*	PR19A	2	RDQ21	T (LVDS)*	
G21	PR5B	2	RDQ8	C	PR18B	2	RDQ21	C	
VCCIO	VCCIO2	2			VCCIO2	2			
H20	PR5A	2	RDQ8	T	PR18A	2	RDQ21	T	
GND	GNDIO2	-			GNDIO2	-			
E22	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*	
F21	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*	
E23	PT82B	1	VREF2_1	C	PT100B	1	VREF2_1	C	
GND	GNDIO1	-			GNDIO1	-			
D22	PT82A	1	VREF1_1	T	PT100A	1	VREF1_1	T	
G20	PT81B	1		C	PT99B	1		C	
J18	PT81A	1		T	PT99A	1		T	
F20	PT80B	1		C	PT98B	1		C	
VCCIO	VCCIO1	1			VCCIO1	1			
H19	PT80A	1		T	PT98A	1		T	
A24	PT79B	1		C	PT97B	1		C	
A23	PT79A	1		T	PT97A	1		T	
E21	PT78B	1		C	PT96B	1		C	
F19	PT78A	1		T	PT96A	1		T	
C22	PT77B	1		C	PT95B	1		C	
GND	GNDIO1	-			GNDIO1	-			
E20	PT77A	1		T	PT95A	1		T	
B22	PT76B	1		C	PT94B	1		C	
VCCIO	VCCIO1	1			VCCIO1	1			
B23	PT76A	1		T	PT94A	1		T	

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P3	PL54B	7	LDQ54	C (LVDS)*
R6	PL55A	7	LDQ54	T
VCCIO	VCCIO7	7		
R8	PL55B	7	LDQ54	C
P2	PL56A	7	LDQ54	T (LVDS)*
P1	PL56B	7	LDQ54	C (LVDS)*
R5	PL57A	7	PCLKT7_0/LDQ54	T
GND	GNDIO7	-		
R7	PL57B	7	PCLKC7_0/LDQ54	C
R4	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
R3	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*
T5	PL60A	6	VREF2_6/LDQ63	T
T7	PL60B	6	VREF1_6/LDQ63	C
T3	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6		
T4	PL61B	6	LDQ63	C (LVDS)*
T6	PL62A	6	LDQ63	T
T8	PL62B	6	LDQ63	C
T2	PL63A	6	LDQS63	T (LVDS)*
GND	GNDIO6	-		
T1	PL63B	6	LDQ63	C (LVDS)*
U7	PL64A	6	LDQ63	T
U5	PL64B	6	LDQ63	C
VCCIO	VCCIO6	6		
U4	PL65A	6	LDQ63	T (LVDS)*
U3	PL65B	6	LDQ63	C (LVDS)*
U8	PL66A	6	LDQ63	T
U6	PL66B	6	LDQ63	C
GND	GNDIO6	-		
U2	PL67A	6	LDQ71	T (LVDS)*
U1	PL67B	6	LDQ71	C (LVDS)*
V7	PL68A	6	LDQ71	T
V5	PL68B	6	LDQ71	C
VCCIO	VCCIO6	6		
V2	PL69A	6	LDQ71	T (LVDS)*
V1	PL69B	6	LDQ71	C (LVDS)*
V8	PL70A	6	LDQ71	T
V6	PL70B	6	LDQ71	C
GND	GNDIO6	-		
W1	PL71A	6	LDQS71	T (LVDS)*
W2	PL71B	6	LDQ71	C (LVDS)*
W5	PL72A	6	LDQ71	T
VCCIO	VCCIO6	6		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
W18	GND	-		
W19	GND	-		
Y14	GND	-		
Y15	GND	-		
Y16	GND	-		
Y17	GND	-		
A2	NC	-		
A3	NC	-		
A4	NC	-		
A5	NC	-		
AB28	NC	-		
AC4	NC	-		
AD23	NC	-		
AE1	NC	-		
AE2	NC	-		
AE29	NC	-		
AE3	NC	-		
AE30	NC	-		
AE4	NC	-		
AE5	NC	-		
AE6	NC	-		
AF1	NC	-		
AF2	NC	-		
AF23	NC	-		
AF26	NC	-		
AF27	NC	-		
AF28	NC	-		
AF29	NC	-		
AF3	NC	-		
AF30	NC	-		
AF4	NC	-		
AF5	NC	-		
AG1	NC	-		
AG13	NC	-		
AG16	NC	-		
AG18	NC	-		
AG2	NC	-		
AG26	NC	-		
AG27	NC	-		
AG28	NC	-		
AG29	NC	-		
AG3	NC	-		
AG30	NC	-		

LFE2M50E/SE Logic Signal Connections: 484 fpBGA

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
D1	PL2A	7	LDQ6	T (LVDS)*
E1	PL2B	7	LDQ6	C (LVDS)*
F1	PL3A	7	LDQ6	T
F2	PL3B	7	LDQ6	C
F5	PL4A	7	LDQ6	T (LVDS)*
VCCIO	VCCIO7	7		
G6	PL4B	7	LDQ6	C (LVDS)*
F4	PL5A	7	LDQ6	T
F3	PL5B	7	LDQ6	C
G1	PL6A	7	LDQS6	T (LVDS)*
GNDIO	GNDIO7	-		
G2	PL6B	7	LDQ6	C (LVDS)*
H1	PL7A	7	LDQ6	T
H2	PL7B	7	LDQ6	C
VCCIO	VCCIO7	7		
H7	PL8A	7	LDQ6	T (LVDS)*
H6	PL8B	7	LDQ6	C (LVDS)*
G3	PL9A	7	VREF2_7/LDQ6	T
H3	PL9B	7	VREF1_7/LDQ6	C
GNDIO	GNDIO7	-		
VCCIO	VCCIO7	7		
H5	PL11A	7	LUM0_SPLLT_IN_A	T (LVDS)*
H4	PL11B	7	LUM0_SPLLC_IN_A	C (LVDS)*
J1	PL12A	7	LUM0_SPLLT_FB_A	T
J2	PL12B	7	LUM0_SPLLC_FB_A	C
GNDIO	GNDIO7	-		
J3	PL13A	7		T (LVDS)*
J4	PL13B	7		C (LVDS)*
J7	PL14A	7		T
VCCIO	VCCIO7	7		
J6	PL14B	7		C
GNDIO	GNDIO7	-		
VCCIO	VCCIO7	7		
K1	PL32A	7	LUM3_SPLLT_IN_A/LDQ36	T (LVDS)*
K2	PL32B	7	LUM3_SPLLC_IN_A/LDQ36	C (LVDS)*
J5	PL33A	7	LUM3_SPLLT_FB_A/LDQ36	T
K5	PL33B	7	LUM3_SPLLC_FB_A/LDQ36	C
VCCIO	VCCIO7	7		
K7	PL34A	7	LDQ36	T (LVDS)*
K6	PL34B	7	LDQ36	C (LVDS)*
L6	PL35A	7	LDQ36	T
L7	PL35B	7	LDQ36	C

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AA14	PB42B	4	BDQ42	C	PB51B	4	BDQ51	C	
VCCIO	VCCIO4	4			VCCIO4	4			
GNDIO	GNDIO4	-			GNDIO4	-			
W17	PB65A	4	BDQ69	T	PB56A	4	BDQ60	T	
AA19	PB65B	4	BDQ69	C	PB56B	4	BDQ60	C	
AC15	PB48A	4	BDQ51	T	PB57A	4	BDQ60	T	
Y18	PB68B	4	BDQ69	C	PB57B	4	BDQ60	C	
AB15	PB49A	4	BDQ51	T	PB58A	4	BDQ60	T	
AC16	PB49B	4	BDQ51	C	PB58B	4	BDQ60	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AA17	PB60A	4	BDQS60****	T	PB59A	4	BDQ60	T	
AB16	PB50B	4	BDQ51	C	PB59B	4	BDQ60	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AA15	PB51A	4	BDQS51****	T	PB60A	4	BDQS60	T	
W16	PB59B	4	BDQ60	C	PB60B	4	BDQ60	C	
Y15	PB52A	4	BDQ51	T	PB61A	4	BDQ60	T	
AC17	PB52B	4	BDQ51	C	PB61B	4	BDQ60	C	
AA18	PB61A	4	BDQ60	T	PB62A	4	BDQ60	T	
Y17	PB61B	4	BDQ60	C	PB62B	4	BDQ60	C	
-	-	-			VCCIO4	4			
GNDIO	GNDIO4	-			-	-			
W15	PB54A	4	BDQ51	T	PB63A	4	BDQ60	T	
AB17	PB54B	4	BDQ51	C	PB63B	4	BDQ60	C	
GNDIO	GNDIO4	-			GNDIO4	-			
VCCIO	VCCIO4	4			VCCIO4	4			
V17	PB73A	4	BDQ69	T	PB72A	4	BDQ69	T	
AA20	PB73B	4	BDQ69	C	PB72B	4	BDQ69	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AD13	VCC	-			LRC_SQ_VCCR3	13			
AF14	PB47A	4	BDQ51	T	LRC_SQ_HDINP3	13		T	
AE13	NC	-			LRC_SQ_VCCIB3	13			
AE14	PB41A	4	VREF2_4/BDQ42	T	LRC_SQ_HDINN3	13		C	
AD16	VCC	-			LRC_SQ_VCCTX3	13			
AF17	PB51B	4	BDQ51	C	LRC_SQ_HDOUPT3	13		T	
AF16	NC	-			LRC_SQ_VCCOB3	13			
AE17	PB50A	4	BDQ51	T	LRC_SQ_HDOUPTN3	13		C	
AD17	VCC	-			LRC_SQ_VCCTX2	13			
AE18	PB53B	4	BDQ51	C	LRC_SQ_HDOUPTN2	13		C	
AD18	NC	-			LRC_SQ_VCCOB2	13			
AF18	PB53A	4	BDQ51	T	LRC_SQ_HDOUPT2	13		T	
AD14	VCC	-			LRC_SQ_VCCR2	13			
AE15	PB48B	4	BDQ51	C	LRC_SQ_HDINN2	13		C	
AD15	NC	-			LRC_SQ_VCCIB2	13			
AF15	PB47B	4	BDQ51	C	LRC_SQ_HDINP2	13		T	
AD19	VCC	-			LRC_SQ_VCCP	13			
AC19	PB57B	4	BDQ60	C	LRC_SQ_REFCLKP	13		T	
AB19	PB59A	4	BDQ60	T	LRC_SQ_REFCLKN	13		C	
AE19	VCCAUX	-			LRC_SQ_VCCAUX33	13			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AA6	NC	-			PL79B	6	LDQ82	C	
AB4	NC	-			PL80A	6	LDQ82	T (LVDS)*	
-	-	-			VCCIO6	6			
AB5	NC	-			PL80B	6	LDQ82	C (LVDS)*	
AA8	NC	-			PL81A	6	LDQ82	T	
AA9	NC	-			PL81B	6	LDQ82	C	
AC1	PL62A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL82A	6	LLM0_GPLLT_IN_A**/LDQS82	T (LVDS)*	
GNDIO	GNDIO6	-			GNDIO6	-			
AC2	PL62B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL82B	6	LLM0_GPLLC_IN_A**/LDQ82	C (LVDS)*	
AC4	PL63A	6	LLM0_GPLLT_FB_A	T	PL83A	6	LLM0_GPLLT_FB_A/LDQ82	T	
AC3	PL63B	6	LLM0_GPLLC_FB_A	C	PL83B	6	LLM0_GPLLC_FB_A/LDQ82	C	
VCCIO	VCCIO6	6			VCCIO6	6			
AC7	PL64A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	PL84A	6	LLM0_GDLLT_IN_A**/LDQ82	T (LVDS)*	
AC6	PL64B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	PL84B	6	LLM0_GDLLC_IN_A**/LDQ82	C (LVDS)*	
AC5	PL65A	6	LLM0_GDLLT_FB_A	T	PL85A	6	LLM0_GDLLT_FB_A/LDQ82	T	
AD3	PL65B	6	LLM0_GDLLC_FB_A	C	PL85B	6	LLM0_GDLLC_FB_A/LDQ82	C	
GNDIO	GNDIO6	-			GNDIO6	-			
AB8	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
AD2	PL67A	6	LDQ71	T (LVDS)*	PL87A	6		T	
AD1	PL67B	6	LDQ71	C (LVDS)*	PL87B	6		C	
AE2	TCK	-			TCK	-			
AE1	TDI	-			TDI	-			
AF2	TMS	-			TMS	-			
AF1	TDO	-			TDO	-			
AG1	VCCJ	-			VCCJ	-			
AH1	VCC	-			LLC_SQ_VCCR3	14			
AK2	PB11A	5	BDQ15	T	LLC_SQ_HDINP3	14		T	
AJ1	NC	-			LLC_SQ_VCCIB3	14			
AJ2	PB11B	5	BDQ15	C	LLC_SQ_HDINN3	14		C	
AH4	VCC	-			LLC_SQ_VCCTX3	14			
AK5	PB13A	5	BDQ15	T	LLC_SQ_HDOUTP3	14		T	
AK4	NC	-			LLC_SQ_VCCOB3	14			
AJ5	PB13B	5	BDQ15	C	LLC_SQ_HDOUTN3	14		C	
AH5	VCC	-			LLC_SQ_VCCTX2	14			
AJ6	PB14B	5	BDQ15	C	LLC_SQ_HDOUTN2	14		C	
AH6	NC	-			LLC_SQ_VCCOB2	14			
AK6	PB14A	5	BDQ15	T	LLC_SQ_HDOUTP2	14		T	
AH2	VCC	-			LLC_SQ_VCCR2	14			
AJ3	PB12B	5	BDQ15	C	LLC_SQ_HDINN2	14		C	
AH3	NC	-			LLC_SQ_VCCIB2	14			
AK3	PB12A	5	BDQ15	T	LLC_SQ_HDINP2	14		T	
AH7	VCC	-			LLC_SQ_VCCP	14			
AG7	PB15A	5	BDQS15	T	LLC_SQ_REFCLKP	14		T	
AF7	PB15B	5	BDQ15	C	LLC_SQ_REFCLKN	14		C	
AJ7	VCCAUX	-			LLC_SQ_VCCAUX33	14			
AK11	PB18A	5	BDQ15	T	LLC_SQ_HDINP1	14		T	
AH11	NC	-			LLC_SQ_VCCIB1	14			
AJ11	PB18B	5	BDQ15	C	LLC_SQ_HDINN1	14		C	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
G7	PL8A	7	LDQ6	T (LVDS)*	NC	-			
G8	PL6A	7	LDQS6****	T (LVDS)*	NC	-			
G9	PL5A	7	LDQ6	T	NC	-			
H19	NC	-			NC	-			
H20	NC	-			NC	-			
H21	NC	-			NC	-			
H22	NC	-			NC	-			
H6	PL8B	7	LDQ6	C (LVDS)*	NC	-			
H8	PL5B	7	LDQ6	C	NC	-			
H9	PL2A	7	LDQ6	T (LVDS)*	NC	-			
J10	PL2B	7	LDQ6	C (LVDS)*	NC	-			
J20	NC	-			NC	-			
J21	NC	-			NC	-			
J9	PL4A	7	LDQ6	T (LVDS)*	NC	-			
K9	PL4B	7	LDQ6	C (LVDS)*	NC	-			
R9	NC	-			NC	-			
U22	NC	-			NC	-			
W9	NC	-			NC	-			
N13	VCCPLL	-			VCCPLL	-			
N18	VCCPLL	-			VCCPLL	-			
V13	VCCPLL	-			VCCPLL	-			
V18	VCCPLL	-			VCCPLL	-			

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** These sysCONFIG pins are dedicated I/O pins for configuration. The outputs are actively driven during normal device operation.

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AG2	PB34A	5	BDQ33	T
AG3	PB34B	5	BDQ33	C
AD13	PB35A	5	BDQ33	T
VCCIO	VCCIO5	5		
AC13	PB35B	5	BDQ33	C
AE14	PB36A	5	BDQ33	T
AC14	PB36B	5	BDQ33	C
AF3	PB37A	5	BDQ33	T
GNDIO	GNDIO5	-		
AF4	PB37B	5	BDQ33	C
-	-	-		
AG4	PB38A	5	BDQ42	T
AG5	PB38B	5	BDQ42	C
GNDIO	GNDIO5	-		
-	-	-		
AD11	PB48A	5	BDQ51	T
AF13	PB48B	5	BDQ51	C
AF12	PB49A	5	BDQ51	T
VCCIO	VCCIO5	5		
AD14	PB49B	5	BDQ51	C
AG8	PB50A	5	BDQ51	T
AF8	PB50B	5	BDQ51	C
AE15	PB51A	5	BDQS51****	T
GNDIO	GNDIO5	-		
-	-	-		
AC15	PB51B	5	BDQ51	C
VCCIO	VCCIO5	5		
GNDIO	GNDIO5	-		
AD15	PB56A	5	BDQ60	T
AF15	PB56B	5	BDQ60	C
AG10	PB57A	5	BDQ60	T
AG9	PB57B	5	BDQ60	C
AH14	PB58A	5	BDQ60	T
AG12	PB58B	5	BDQ60	C
VCCIO	VCCIO5	5		
AG15	PB59A	5	BDQ60	T
AG13	PB59B	5	BDQ60	C
GNDIO	GNDIO5	-		
AF16	PB60A	5	BDQS60	T
AH15	PB60B	5	BDQ60	C
AC16	PB61A	5	VREF2_5/BDQ60	T
AE16	PB61B	5	VREF1_5/BDQ60	C
AG11	PB62A	5	PCLKT5_0/BDQ60	T

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
K11	NC	-			NC	-		
K12	NC	-			NC	-		
K13	NC	-			NC	-		
K23	NC	-			NC	-		
K24	NC	-			NC	-		
K25	NC	-			NC	-		
K26	NC	-			NC	-		
L11	NC	-			NC	-		
L12	NC	-			NC	-		
L13	NC	-			NC	-		
L14	NC	-			NC	-		
L21	NC	-			NC	-		
L22	NC	-			NC	-		
L23	NC	-			NC	-		
L24	NC	-			NC	-		
L25	NC	-			NC	-		
L26	NC	-			NC	-		
M11	NC	-			NC	-		
M24	NC	-			NC	-		
M25	NC	-			NC	-		
M6	NC	-			NC	-		
M8	NC	-			NC	-		
N10	NC	-			NC	-		
N11	NC	-			NC	-		
P10	NC	-			NC	-		
P25	NC	-			NC	-		
P26	NC	-			NC	-		
R9	NC	-			NC	-		
T11	NC	-			NC	-		
U11	NC	-			NC	-		
W11	NC	-			NC	-		
Y10	NC	-			NC	-		
Y11	NC	-			NC	-		
R15	VCCPLL	-			VCCPLL	-		
R20	VCCPLL	-			VCCPLL	-		
Y15	VCCPLL	-			VCCPLL	-		
Y20	VCCPLL	-			VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70, and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.